IN THE SPECIFICATION:

Page 1, line 4, insert:

Background of the Invention

Page 2, line 27, insert:

Summary of the Invention

Page 6, line 11, insert:

Brief Description of the Drawings

line 28, insert:

Description of the Preferred Embodiments

Page 7, lines 4-6:

In other words, the substrate $\frac{12 \text{ [sic]}}{12 \text{ [sic]}} \frac{10}{10}$ is U-shaped in cross-section, with the object 12 to be treated or cleaned-hereinafter called the wafer-being arranged above the cross bar that forms the base panel 14.